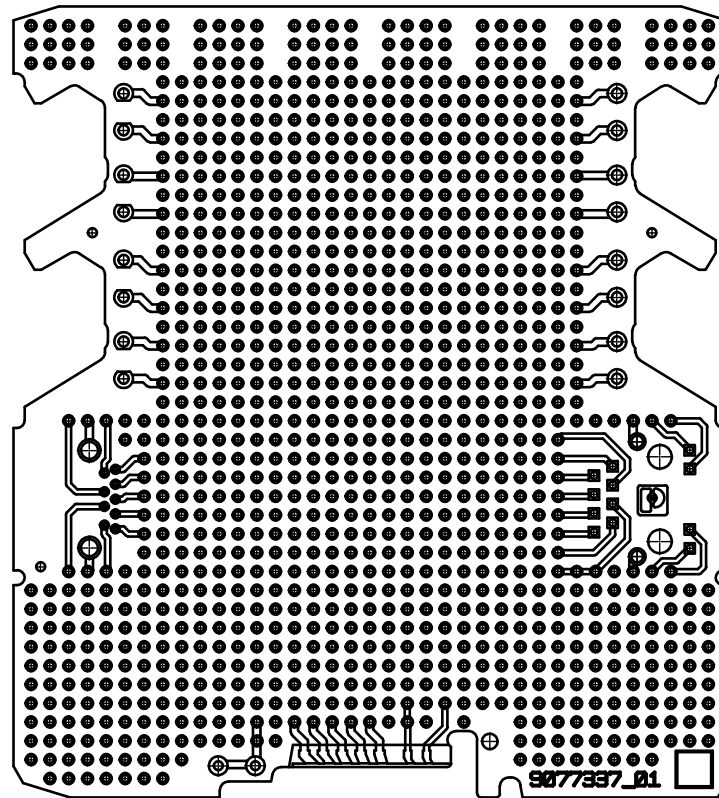
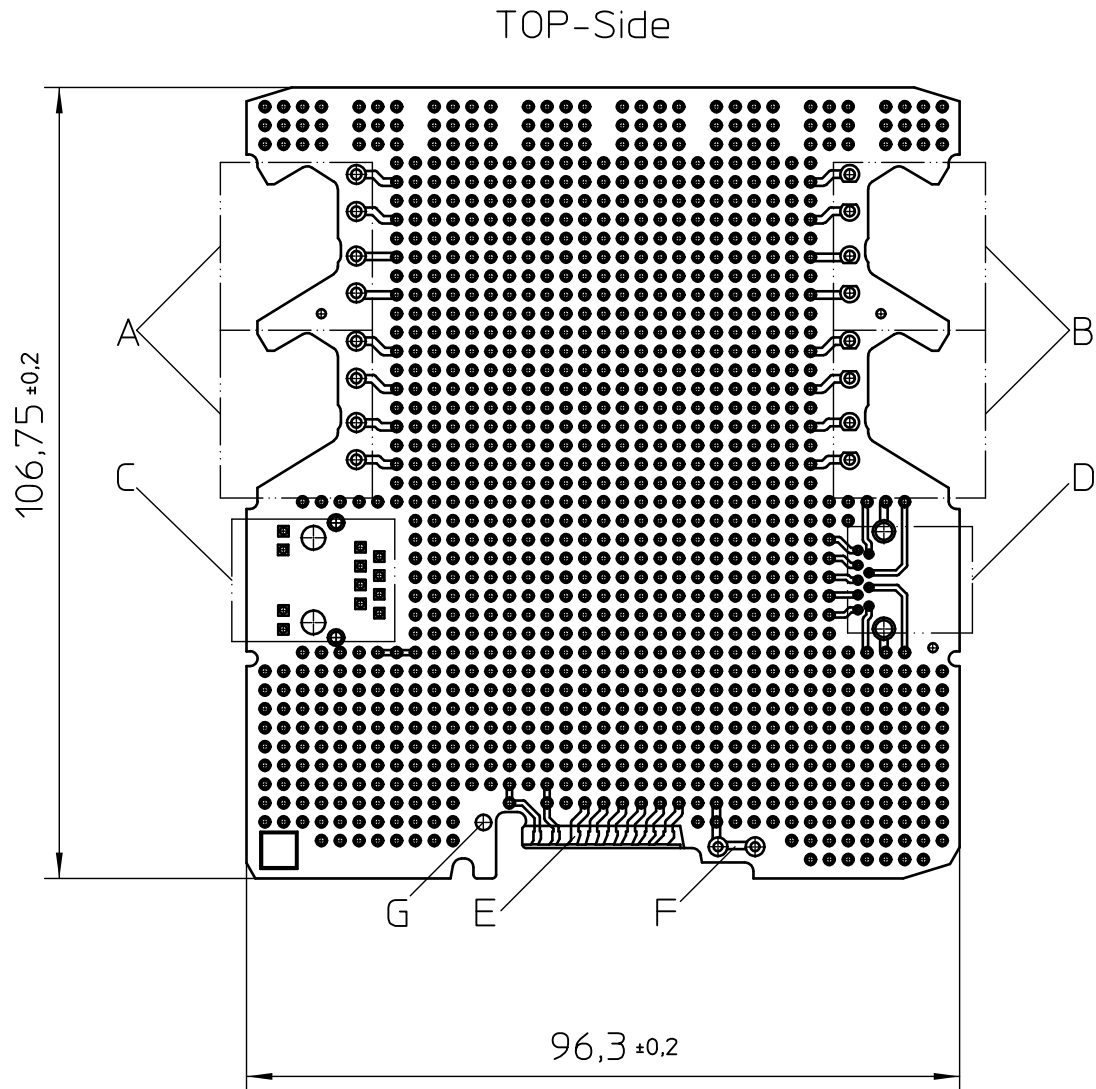


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- General Information
- Simplified representation
 - Document excluded from change process
 - CAD Data see Download-Center on www.phoenixcontact.com
 - Linear dimensions [mm]
 - Dot matrix pitch: 2,54mm ; drill size: Ø1
 - Thickness: 1,6±0,2
 - Application: ICS25-B100x110 DEV-KIT

- Terminal area for:
- A) ICC25-H/4L5,0
 - B) ICC25-H/4R5,0
 - C) VS-08-BU-RJ45/LP-1
 - D) KUSBX-AS1N9-1-BL30. 3.0A
 - E) Pad for TBUS CONTACT, surface chem. Ni,Au
 - F) FE CONTACT
 - G) Hole for latching with ICS25-B100x110...

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